



Part no.	CL-SP2808USO-02		
Emitting color	ORANGE		
Material	AlGaInP		
Picture			

■Absolute Maximum Ratings at (TA=25°C)

Part No.	REVERSE VOLTAGE (<100 uA)	D.C.FORWARD CURRENT	OPERATING TEMPERATURE RANGE	STORAGE TEMPERATURE RANGE	LEAD SOLDERING TEMP.
CL-SP2808USO-02	5.0V	30mA	-30°CTO +85°C	-40°CTO +90°C	250 FOR 4 SEC

■Electrical/Optical Characteristics at TA=25 °C

Part No.	WAVELENGTH Hue @20mA (nm)		FORWARD VOLTAGE @20mA(V)		Reverse Current	LUMI INTEN @20mA	NSITY
CD2000LICO	MIN	MAX	MIN	MAX	IR(VR=5V)	MIN	MAX
SP2808USO	600	612	1.8	2.4	10uA	200	700

IV :Tolerance each Binlimit is $\pm 15\%$ VF: Tolerance each Binlimit is $\pm 15\%$

■WAVELENGTH(IF=20mA.Ta=25 °C)

COLOR	ORANGE		
ITEM	λ d 20mA(nm)		
BIN	MIN MAX		
01	600	603	
O2	603	606	
03	606	609	
O4	609	612	

■LUMINOUS INTENSITY@20mA(mcd)

COLOR	ORANGE			
ITEM	IV 20mA(mcd)			
BIN	MIN MAX			
L8	200	300		
R1	300	400		
R2	400	500		
S1	500	600		
S2	600	700		

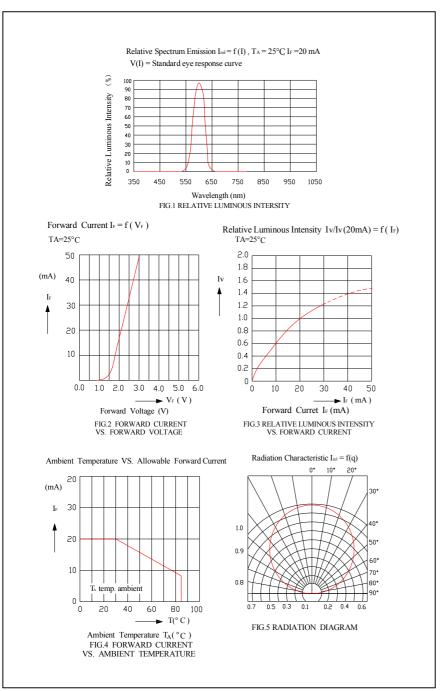
■ FORWARD VOLTAGE@20mA(V)

COLOR	ORANGE		
ITEM	VF 20mA(V)		
BIN	MIN MAX		
В	1.8	1.9	
B-1	1.9	2.0	
C	2.0	2.1	
C-1	2.1	2.2	
D	2.2	2.3	
D-1	2.3	2.4	

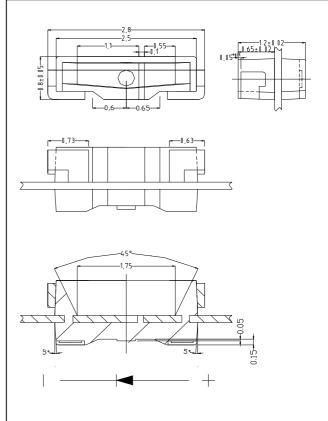




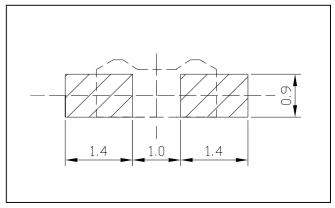
Directivity



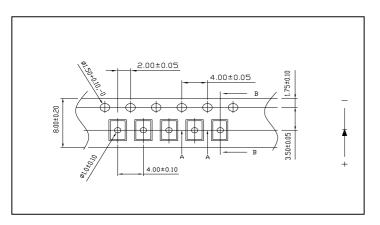
■ Dimensions(Unit:mm)

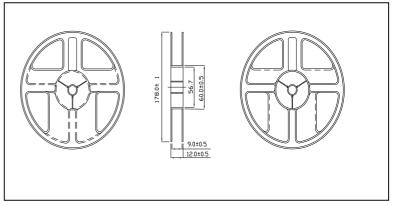


■ recommended



■ Package specifications (mm)









RELIABILITY

TEST ITEMS AND RESULTS					
Test Item		Test Conditions	Note	Number of Damaged	
Solderability (Reflow Soldering)	JEITA ED-4701 300-301	Tald=250±5℃ 4sec	1 time over 95%	0/50	
Thermal Shock	MIL-STD 202-107D MIL-STD 705-1051 MIL-STD 808-1011	0°C − 90°C 15sec. 15sec	20cycles	0/50	
Temperature Cycle	JEITA ED-4701 100-105	-40°C - 25°C - 90°C - 25°C 30min. 5min. 30min. 5min	100 cycles	0/50	
Moisture Resistance Cyclic	JEITA ED-4701 200-203	25°C - 65°C10°C 90%RH 24hrs/1cycle	10 cycles	0/50	
Temperature Humidity Storage	MIL-STD202-103B JIS-C-7021 B-11	Ta=60°C RH=90%	1000hrs	0/50	
Low Temperature Storage	JIS-C-7021 B-12	Ta=-40°C	1000hrs	0/50	
Steady State Operating Life of High Humidity Heat	MIL-STD202-103B JIS-C-7021 B-11	85℃,RH=85%,If=20mA	500hrs	0/50	

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	VF(V)	IF=20mA	Over U*1.2
Reverse current	IR (uA)	VR=5V	Over U*2
Luminous intensity	IV (mcd)	IF=20mA	Below S*0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

LED

Application (Soldering)

Manual soldering (We do not recommend this method strongly.)

Soldering tin material: tin 6/4 alloy or contained Ag.

To prevent cracking, please bake before manual soldering.

seconds. If the temperature become higher, apply in a shorter time (1sec)

In manual soldering, take care not to damage the package especially terminal or resin.

(Do not give stress to the product when soldering.)

Do not use again it you remove the soldeGREEN ORANGE product.

It is recommended using an iron with a temperature control.

Reflow Soldering

Recommend tin glue specifications:

Melting temperature:150-260°C

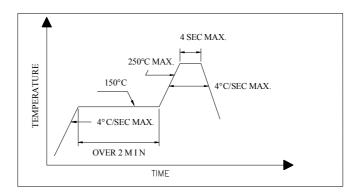
Contains: Sn 96.5%, Ag 3.0%, Gu0.5 % JIS Z 3282TEST





Never take next process until the component is cooled down to room temperature after reflow.

The recommended reflow soldering profile (measuring on the surface of the LED resin) is following:



Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as lsopropyl Alcohol(IPA) is recommended.

Temperature Time: <50°C*30sec, or <30°C*3min

Ultra sonic cleaning: <15W/bath; Bath volume:1liter max.

Curing: 100 max, <3min

Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment is grounding well. Using an ionzer fan is recommended.

Cautions of Design and Applications

It should be done to connect with a current-limiting serial resistor. Avoid to drive reverse voltage over the specifications on LEDwhen ON/OFF.

Any application should refer to the specifications of absolute maximum ratings.

The dimensions of the recommended soldering pattern may mot meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering.

Do not contact with any component on the assembly board.